

Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 218251US6X PCT		SERIAL NO. New US PCT application based on PCT/FR00/02065	
LIST OF REFERENCES CITED BY APPLICANT				APPLICANT Philippe ROBERT			
				FILING DATE Herewith		GROUP	
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE	
MG	AA	4 978 639	12/18/90	Simon S. CHAN et al.			
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						
FOREIGN PATENT DOCUMENTS							
	DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION YES NO			
MG	AO	0 926 726	06/30/99	EP		No	
	AP						
	AQ						
	AR						
	AS						
	AT						
	AU						
	AV						
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)							
MG	AW	A. GULDAN et al.: "Method for producing via-connections in semiconductor wafers using a combination of plasma and chemical etching" IEEE TRANSACTIONS ON ELECTRON DEVICES, US, IEEE INC., vol. ED-30, no. 10, pages 1402-1403 10/01/83					
	AX						
	AY						
	AZ						
<input type="checkbox"/> Additional References sheet(s) attached							
Examiner <i>Maria Guerrero</i>				Date Considered <i>6-20-03</i>			
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							